

**CON-SERV INC
STANDARD OPERATING PROCEDURE**

D.P. No 1000

EFFECTIVE DATE: January 1, 1979

DESCRIPTION:
Preparation of etched TFE
tape for bonding.

Q.C. APPRVD.: *RE*

SHT. 1 OF 1

REVISED DATE: October 28, 1996

STEP	PROCEDURE	COMMENTS
1.	Cut tape to appropriate size.	
2.	Wipe the etched side with a clean rag soaked in a solvent. Wipe to remove any contaminants (oil, dirt, fingerprints, etc.)	
3.	Stack clean TFE with etched surfaces together.	

RECEIVED
 CK'D BY _____ OK'D BY _____
 DEC 15 2006
 RESUBMIT _____ APPROVED
 BY _____ DATE 01-05-07

056 55